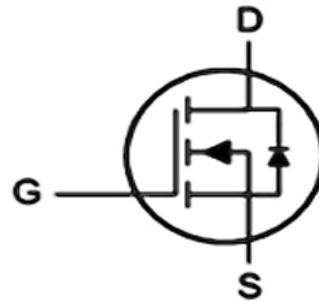


Description

This N-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.

Features

- 1) $V_{DS}=71V, I_D=90A, R_{DS(ON)}<6.8m\ \Omega @V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra $R_{DS(ON)}$.
- 5) Excellent package for good heat dissipation.



Absolute Maximum Ratings $T_C=25^\circ\text{C}$, unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	71	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current-	90	A
	Continuous Drain Current- $T_C=100^\circ\text{C}$	63	
P_D	Power Dissipation	170	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.88	$^\circ\text{C}/\text{W}$

Package Marking and Ordering Information

Part NO.	Marking	Package
RYN71A90TA	RYN71A90TA	TO-220

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\ \mu\text{A}$	71	74	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=500V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 30V, V_{DS}=0V$	---	---	± 100	nA
On Characteristics						
$V_{GS(th)}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\ \mu\text{A}$	2	3	4	V
$R_{DS(ON)}$	Drain-Source On Resistance	$V_{GS}=10V, I_D=40A$	---	5.9	6.8	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$	---	4871	---	pF
C_{oss}	Output Capacitance		---	630.6	---	
C_{rss}	Reverse Transfer Capacitance		---	410.3	---	
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=30V, I_D=42A,$ $R_{GEN}=10\ \Omega,$ $V_{GS}=10V$	---	36.1	---	ns
t_r	Rise Time		---	54.3	---	ns
$t_{d(off)}$	Turn-Off Delay Time		---	85.2	---	ns
t_f	Fall Time		---	37.3	---	ns
Q_g	Total Gate Charge	$V_{GS}=10V, V_{DS}=48V,$ $I_D=84A$	---	85.7	---	nC
Q_{gs}	Gate-Source Charge		---	23.2	---	nC
Q_{gd}	Gate-Drain "Miller" Charge		---	31.2	---	nC
Drain-Source Diode Characteristics						
V_{SD}	Source-Drain Diode Forward Voltage	$V_{GS}=0V, I_S=20A$	---	---	1.2	V
t_{rr}	Reverse Recovery Time	$I_F=84A$	---	88.3	---	ns
Q_{rr}	Reverse Recovery Charge	$di_F/dt=100A/\mu\text{s}$ (Note3)	---	65.9	---	nC

Typical Characteristics $T_J=25^\circ\text{C}$ unless otherwise noted

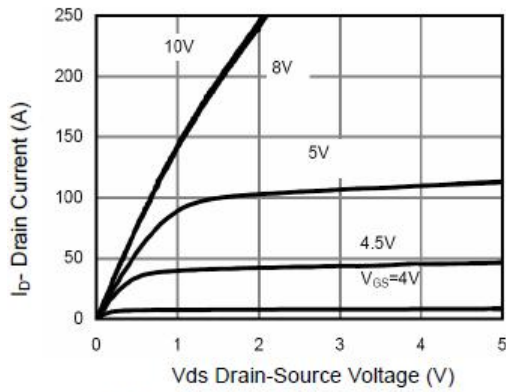


Figure 1 Output Characteristics

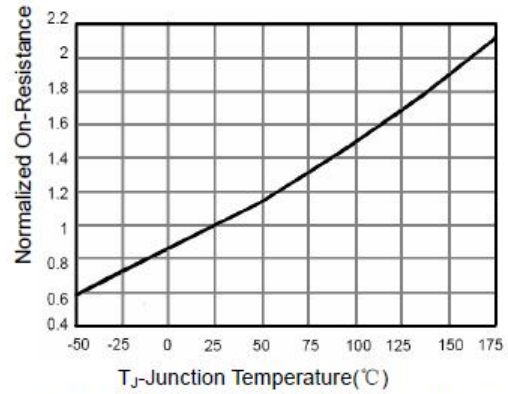


Figure 4 Rds(on)-Junction Temperature

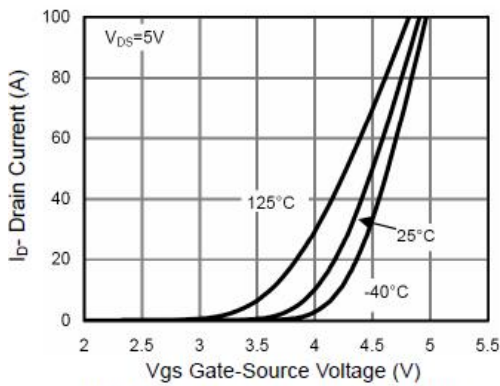


Figure 2 Transfer Characteristics

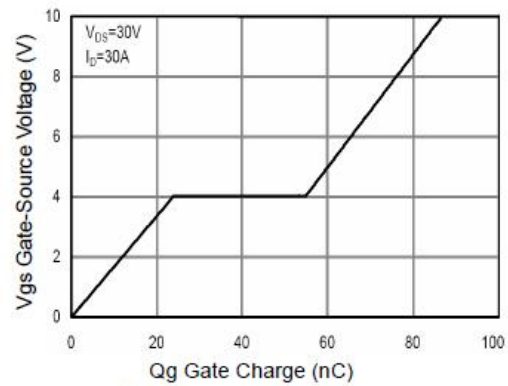


Figure 5 Gate Charge

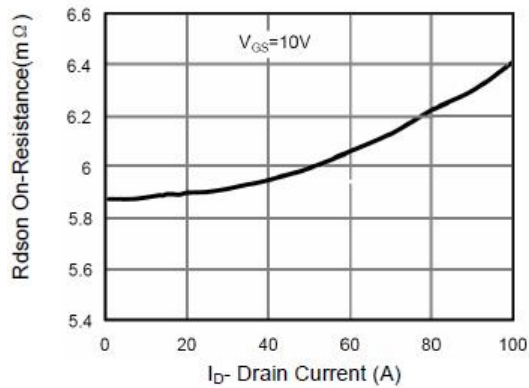


Figure 3 Rds(on)-Drain Current

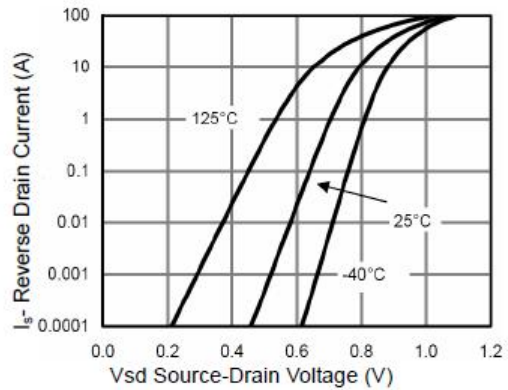


Figure 6 Source-Drain Diode Forward

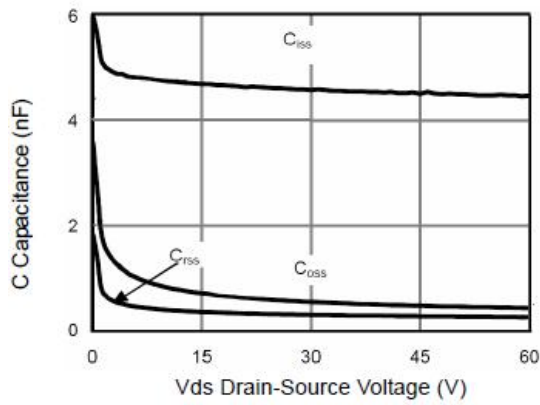


Figure 7 Capacitance vs Vds

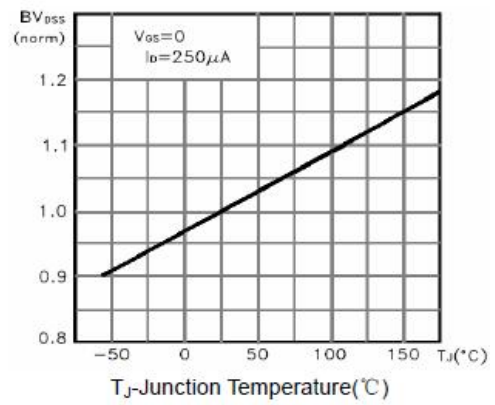


Figure 9 BV_{DSS} vs Junction Temperature

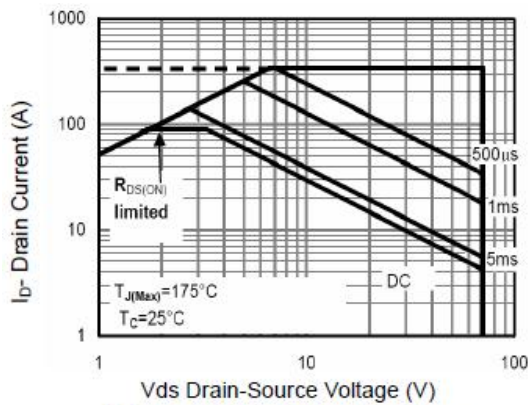


Figure 8 Safe Operation Area

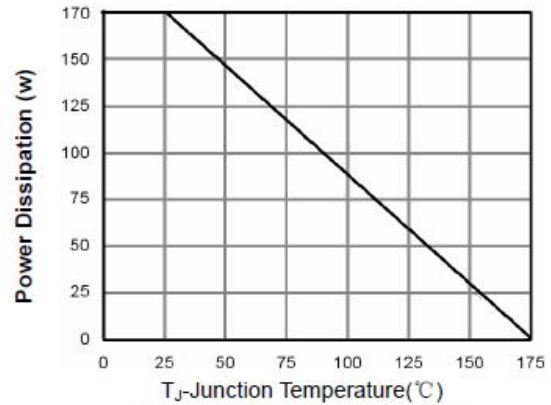


Figure 10 Power De-rating

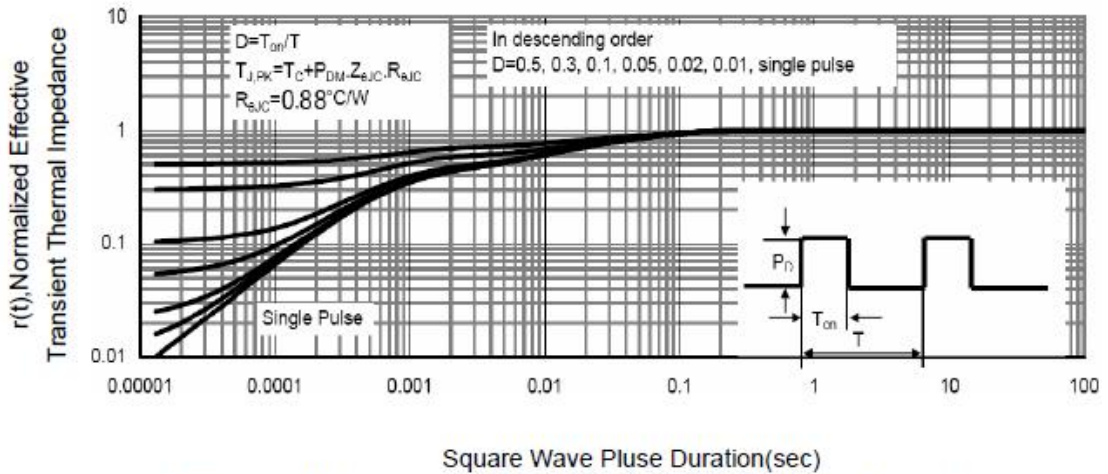


Figure 11 Normalized Maximum Transient Thermal Impedance